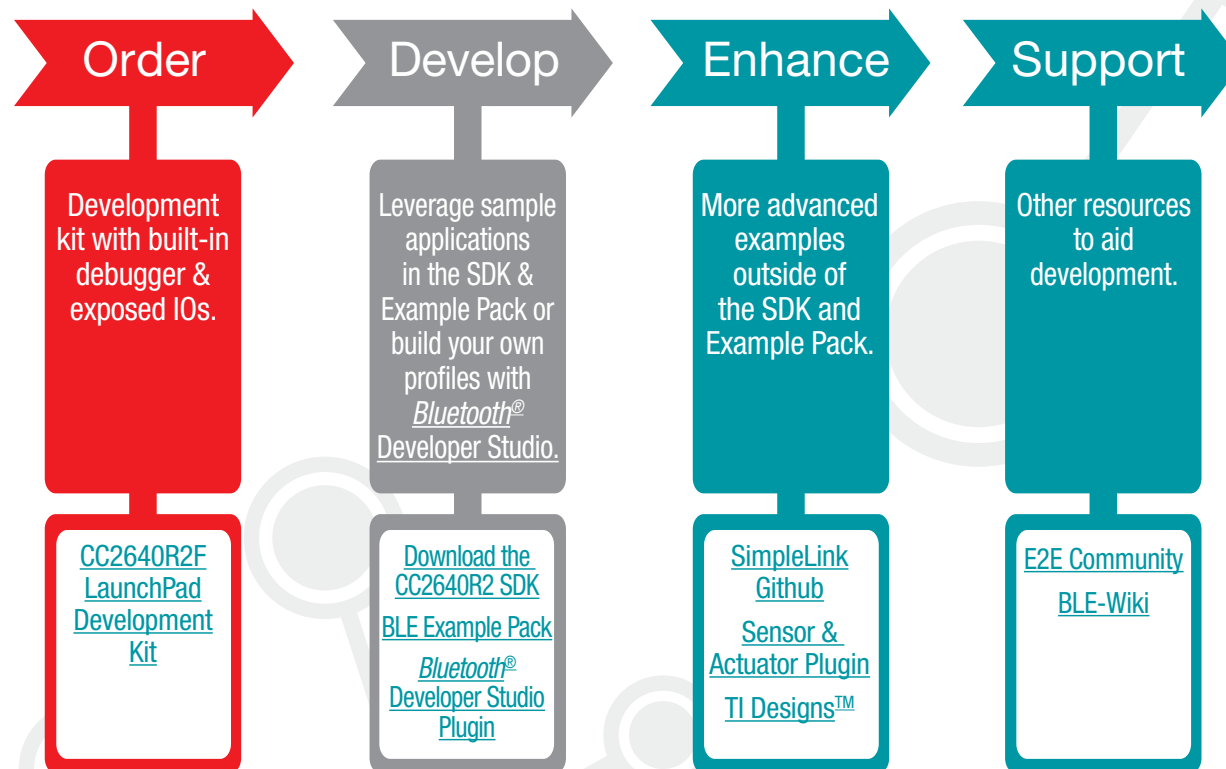


Getting started with SimpleLink™ *Bluetooth*® low energy CC2640R2F for IAR users

275 KB of NV memory including 128 KB of flash, *Bluetooth*® 5 compliant



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